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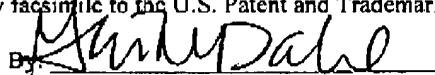
S/N 10/775,656

PATENTIN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	YAMASHITA ET AL.	Examiner:	DINH
Serial No.:	10/775,656	Group Art Unit:	2841
Filed:	FEBRUARY 9, 2004	Docket No.:	10873.1397US01
Title:	ELECTRONIC COMPONENT BUILT-IN MODULE AND METHOD OF MANUFACTURING THE SAME		

CERTIFICATE UNDER 37 CFR 1.6(d)

I hereby certify that this paper is being transmitted by facsimile to the U.S. Patent and Trademark office on March 2, 2006.

By: 
Name: Gina DahlAMENDMENT AND RESPONSE

Mail Stop AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action mailed December 2, 2005, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims that begins on page 2 of this paper.

Remarks begin on page 6 of this paper.